



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

FMS6346E

Six-Channel, Selectable SD / HD Video Filter Driver with Disable

Features

- Three Selectable 8/30MHz (SD/HD) Filters
- Three Fixed 8MHz (SD) Filters
- Enable / Disable Pin
- Input Clamp and Bias
- Single Video Load Drive ($2V_{PP}$, 150Ω , $A_V = 6dB$)
- AC- or DC-Coupled Inputs
- AC- or DC-Coupled Outputs
- Robust Output ESD Protection: 9kV HBM

Applications

- Cable and Satellite Set-Top Boxes
- DVD Players
- HDTV
- Portable Media Players (PMP)
- Personal Video Recorders (PVR)
- Video On Demand (VOD)

Description

FMS6346E VoltagePlus™ video filter is intended to replace passive LC filters and drivers with a cost-effective integrated device. Six Butterworth filters improve image quality compared to typical passive solutions. The combination of low-power Standard-Definition (SD) and High-Definition (HD) filters greatly simplifies DVD video output circuitry. Three channels offer fixed SD 6th-order filters, while the other three are selectable between SD and HD 7th-order filters.

The FMS6346E offers a fixed gain of 6dB.

The FMS6346E may be directly driven by a DC-coupled DAC output or an AC-coupled signal. Internal diode clamps and bias circuitry may be used if AC-coupled inputs are required (*see the Applications Information section for details*).

The outputs can drive AC- or DC-coupled single (150Ω) video loads. DC-coupling the outputs remove the need for output coupling capacitors. The input DC levels are offset approximately +280mV at the output.

Ordering Information

Part Number	Operating Temperature Range	Gain Setting	Package	Packing Method
FMS6346EMTC20X	-40°C to +85°C	6dB	20-Lead, Thin-Shrink Small-Outline Package (TSSOP)	2500 Units per Reel

Functional Block Diagram

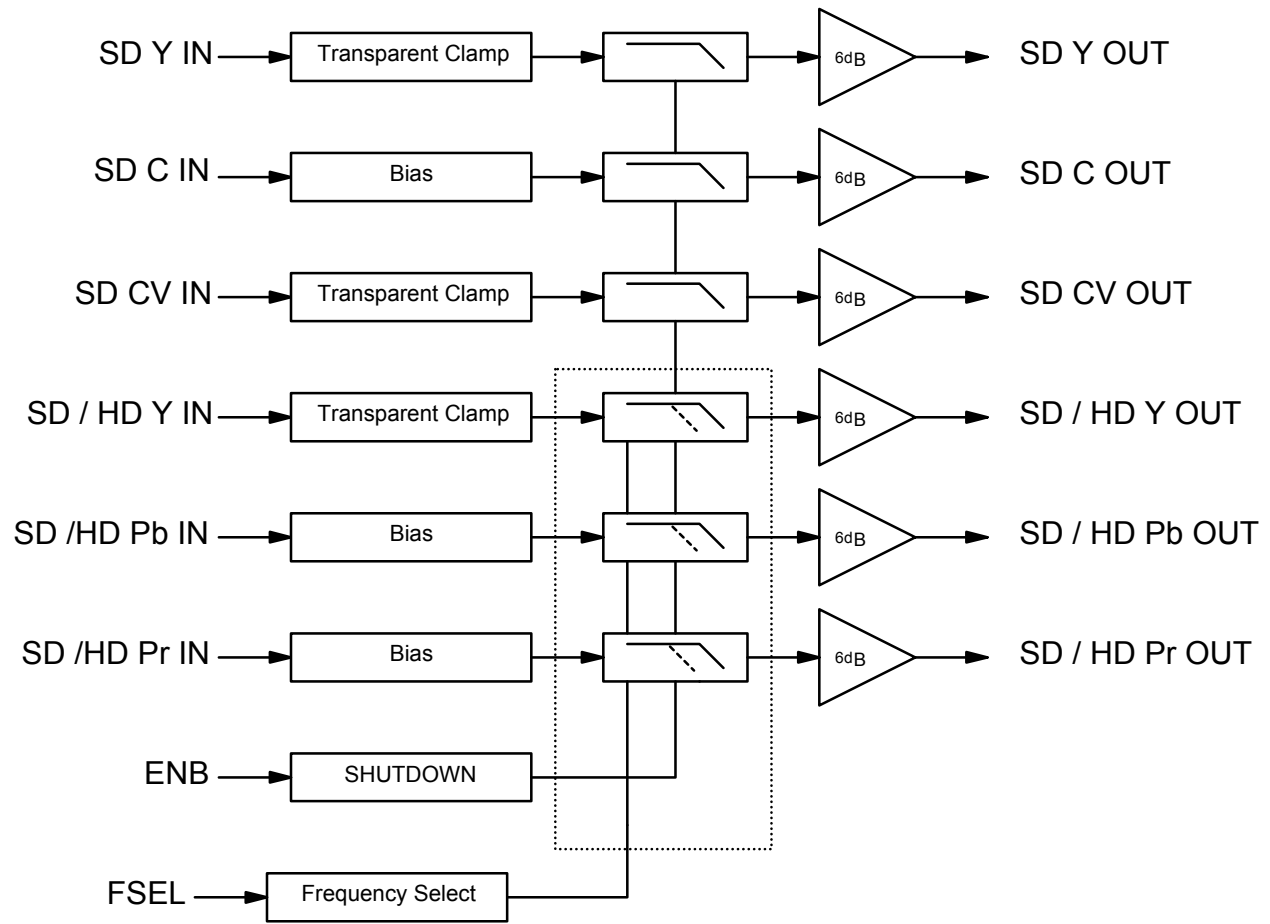


Figure 1. Block Diagram



Pin Configuration

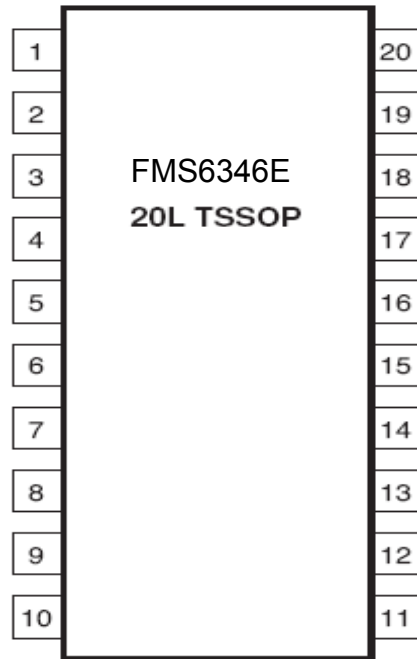


Figure 2. Pin Layout

Pin Definitions

Pin#	Name	Type	Description
1	SD Y IN1	Input	SD Y Video Input, Channel 1
2	SD C IN2	Input	SD C Video Input, Channel 2
3	SD CV IN3	Input	SD CV Video Input, Channel 3
4	ENB	Input	Enable / Disable, ENB = GND (0): Device Enabled; ENB = HIGH (1): Device Disabled
5	V _{CC}	Input	+3.3V or 5.0V Supply
6	F _{CSEL}	Input	Selects Filter Corner Frequency for Pins 7, 8, and 9: "0" = SD, "1" = HD
7	SD/HD Y IN1	Input	Selectable SD or HD Y Video Input, Channel 1
8	SD/HD Pb IN2	Input	Selectable SD or HD Pb Video Input, Channel 2
9	SD/HD Pr IN3	Input	Selectable SD or HD Pr Video Input, Channel 3
10	N/C	Input	No Connection
11	N/C	Input	No Connection
12	SD/HD Pr OUT3	Output	Filtered SD or HD Pr Video Output, Channel 3
13	SD/HD Pb OUT2	Output	Filtered SD or HD Pb Video Output, Channel 2
14	SD/HD Y OUT1	Output	Filtered SD or HD Y Video Output, Channel 1
15	N/C	Input	No Connection
16	GND	Input	Must Be Tied to Ground
17	GND	Input	Must Be Tied to Ground
18	SD CV OUT3	Output	Filtered SD CV Video Output, Channel 3
19	SD C OUT2	Output	Filtered SD C Video Output, Channel 2
20	SD Y OUT1	Output	Filtered SD Y Video Output, Channel 1

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	DC Supply Voltage	-0.3	6.0	V
V _{IO}	Analog and Digital I/O	-0.3	V _{CC} +0.3	V
I _{OUT}	Output Current, Any One Channel, Do Not Exceed		50	mA

Reliability Information

Symbol	Parameter	Min.	Typ.	Max.	Unit
T _J	Junction Temperature			+150	°C
T _{STG}	Storage Temperature Range	-65		+150	°C
T _L	Reflow Temperature			+260	°C
Θ _{JA}	Thermal Resistance, JEDEC Standard Multi-Layer Test Boards, Still Air		74		°C/W

Electrostatic Discharge Information

Symbol	Parameter	Max.	Unit
ESD	Human Body Model, JESD22-A114	9	kV
	Charged Device Model, JESD22-C101	2	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Typ.	Max.	Unit
T _A	Operating Temperature Range	-40		+85	°C
V _{CC}	Supply Voltage Range	3.135	3.300	5.250	V

DC Electrical Characteristics

Unless otherwise noted, $T_A=25^\circ\text{C}$, $V_{CC}=3.3\text{V}$, $R_{SOURCE}=37.5\Omega$, inputs AC coupled with $0.1\mu\text{F}$, all outputs AC coupled with $220\mu\text{F}$ into 150Ω loads, and referenced to 400kHz .

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
I_{CC}	Supply Current ⁽¹⁾	$V_{CC} = 3.3\text{V}$, No Load, EN=LOW		50	62	mA
		$V_{CC} = 5.0\text{V}$, No Load, EN = LOW		60	70	mA
I_{CC_SD}	Shutdown Supply Current	$V_{CC} = 3.3\text{V}$ or 5.0V , No Load, EN = HIGH		10	200	μA
V_{IN}	Video Input Voltage Range	Referenced to GND if DC Coupled		1.2		V_{PP}
V_{IL}	Digital Input Low ⁽¹⁾	EN = LOW, Device Enabled	0		0.8	V
V_{IH}	Digital Input High ⁽¹⁾	EN = HIGH, Device Disabled	2.4		V_{CC}	V
I_{EN_Low}	Input Current	$V_{IL} = 0.8\text{V}$		0.01	1.00	μA
I_{EN_HIGH}	Input Current	$V_{IH} = 2.4\text{V}$		0.01	1.00	μA
PSRR	Power Supply Rejection Ratio			-50		dB

Note:

- 100% tested at $T_A=25^\circ\text{C}$.

Standard-Definition (480i) Electrical Characteristics

Unless otherwise noted, $T_A=25^\circ\text{C}$, $V_{IN}=1V_{PP}$, $V_{CC}=3.3\text{V}$, $R_{SOURCE}=37.5\Omega$, all inputs AC coupled with $0.1\mu\text{F}$, all outputs AC coupled with $220\mu\text{F}$ into 150Ω loads, and referenced to 400kHz .

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
AV_{SD}	Channel Gain ⁽²⁾	All SD Channels, DC	5.8	6.0	6.2	dB
$f_{0.1\text{dBSD}}$	-0.1dB Flatness	All SD Channels		5.5		MHz
$f_{1\text{dBSD}}$	-1dB Flatness ⁽²⁾	All SD Channels	5.50	7.15		MHz
f_{cSD}	-3dB Bandwidth ⁽²⁾	All SD Channels	6.5	8.0		MHz
f_{SBS}	Attenuation (Stopband Reject) ⁽²⁾	All SD Channels at $f = 27\text{MHz}$	50	60		dB
DG	Differential Gain	All SD Channels		0.2		%
DP	Differential Phase	All SD Channels		0.4		°
THD	Total Harmonic Distortion, Output	$V_{OUT} = 1.4V_{PP}$, 3.58MHz		0.4		%
X_{TALKSD}	Crosstalk (Channel-to-Channel)	1MHz		-70		dB
SNR	Signal-to-Noise Ratio ⁽³⁾	NTC-7 Weighting, 100kHz to 4.2MHz		72		dB
t_{pdSD}	Propagation Delay	Delay from Input to Output, 4.5MHz		84		ns
CLG_{SD}	Chroma Luma Gain	$f = 3.58\text{MHz}$ (Refer to SD_{IN} at 400kHz)		100		%
CLD_{SD}	Chroma Luma Delay	$f = 3.58\text{MHz}$ (Refer to SD_{IN} at 400kHz)		6		ns

Notes:

- 100% tested at $T_A=25^\circ\text{C}$.
- $\text{SNR} = 20 \cdot \log(714\text{mV} / \text{rms noise})$.

High-Definition Electrical Characteristics

Unless otherwise noted, $T_A=25^\circ\text{C}$, $V_{IN}=1V_{PP}$, $V_{CC}=3.3V$, $R_{SOURCE}=37.5\Omega$, all inputs AC coupled with $0.1\mu\text{F}$, all outputs AC coupled with $220\mu\text{F}$ into 150Ω loads, and referenced to 400kHz .

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
AV_{HD}	Channel Gain ⁽⁴⁾	All HD Channels, DC	5.8	6.0	6.2	dB
$BW_{0.5dB}$	+/-0.5dB Bandwidth ⁽⁴⁾	All HD Channels		28		MHz
BW_{-1dB}	-1dB Bandwidth ⁽⁴⁾	All HD Channels	28	31		MHz
BW_{-3dB}	-3dB Bandwidth ⁽⁴⁾	All HD Channels	30	32		MHz
$Att_{37.125M}$	Normalized Stopband Attenuation ⁽⁴⁾	$R_{SOURCE} = 75\Omega$, $f = 37.325\text{MHz}$		6.5		dB
$Att_{44.25M}$		$R_{SOURCE} = 75\Omega$, $f = 44.25\text{MHz}$		14.5		dB
$Att_{74.25M}$		$R_{SOURCE} = 75\Omega$, $f = 74.25\text{MHz}$	40	44		dB
Att_{78M}		$R_{SOURCE} = 75\Omega$, $f = 78\text{MHz}$	42	46		dB
THD1	Output Distortion (All Channel)	$f = 10\text{MHz}$; $V_{OUT} = 1.4V_{PP}$		0.4		%
THD2		$f = 15\text{MHz}$; $V_{OUT} = 1.4V_{PP}$		0.4		%
THD2		$f = 30\text{MHz}$; $V_{OUT} = 1.4V_{PP}$		0.4		%
X_{TALKHD}	Crosstalk (Channel-to-Channel)	$f = 1.0\text{MHz}$; $V_{OUT} = 1.4V_{PP}$		-60		dB
SNR	Signal-to-Noise Ratio ⁽⁵⁾	Weighted; 100kHz to 30MHz		72		dB
t_{pdHD}	Propagation Delay	Delay from Input to Output, 10MHz		24		ns

Notes:

4. 100% tested at 25°C .
5. $SNR=20 \cdot \log(714\text{mV} / \text{rms noise})$.

Typical Performance Characteristics

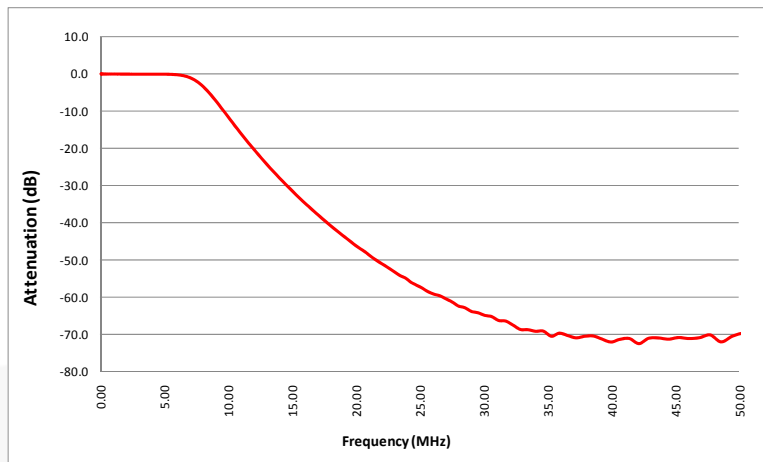


Figure 3. SD Frequency Response

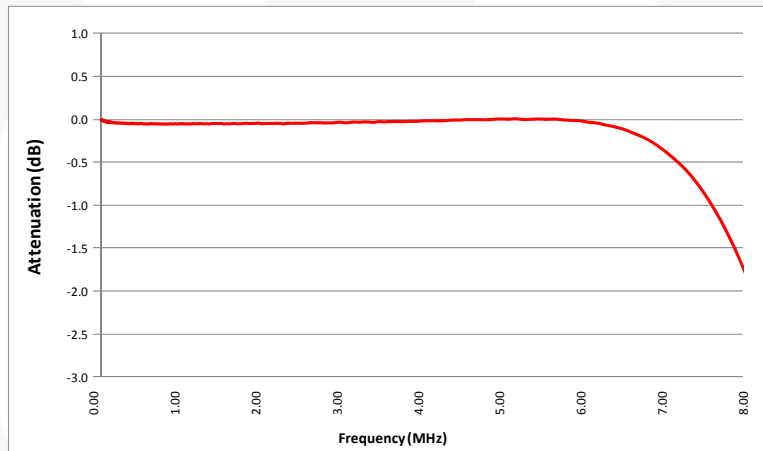


Figure 4. SD Frequency Response (Flatness)

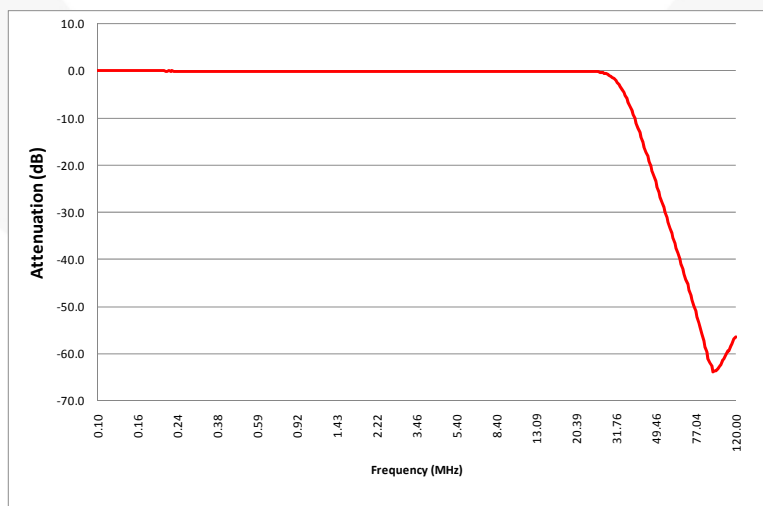


Figure 5. HD Frequency Response

Typical Performance Characteristics (Continued)

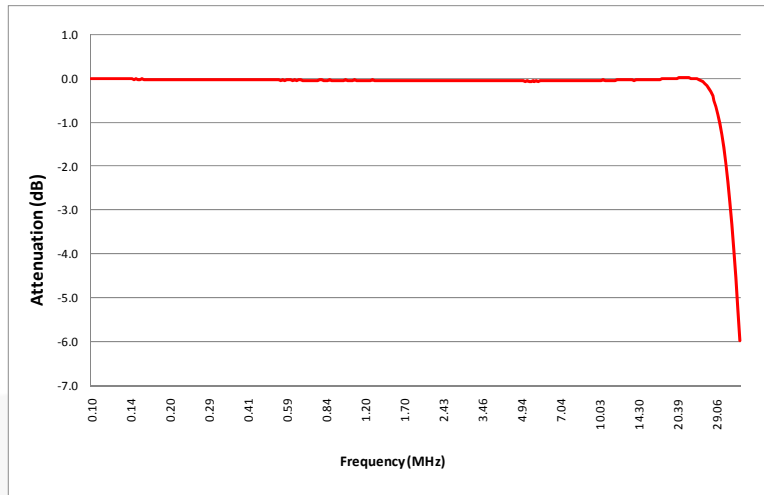


Figure 6. HD Frequency Response (Flatness)

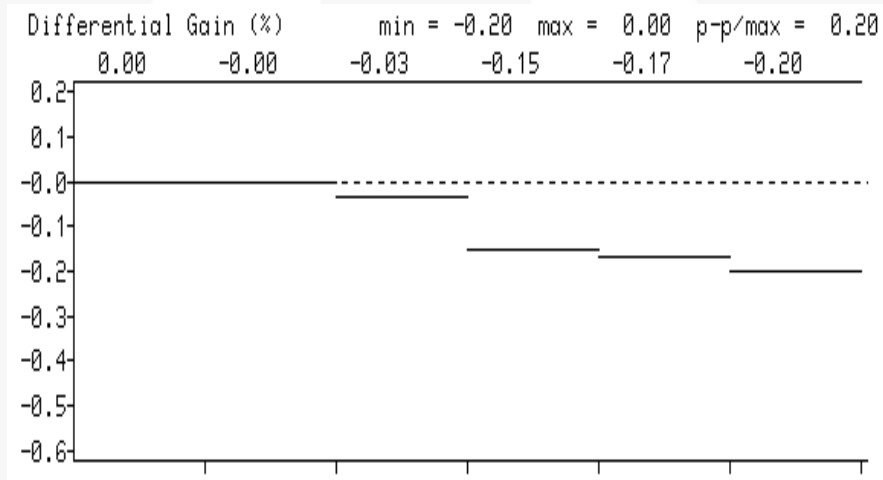


Figure 7. Differential Gain

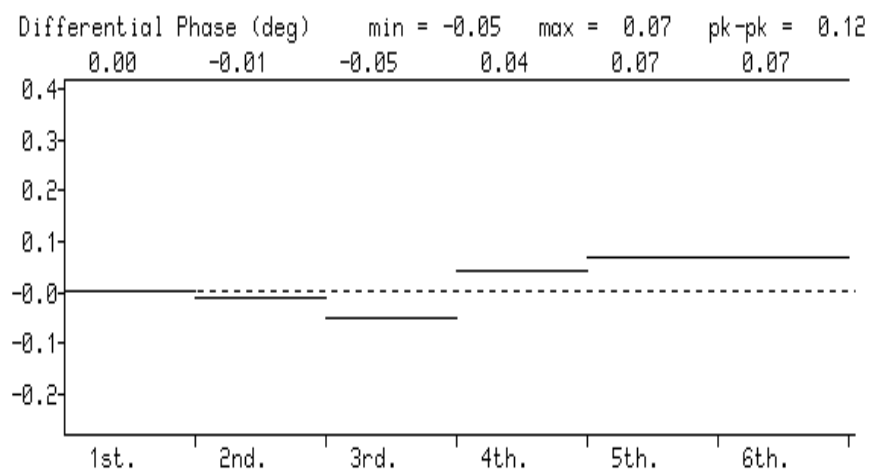


Figure 8. Differential Phase

Typical Application

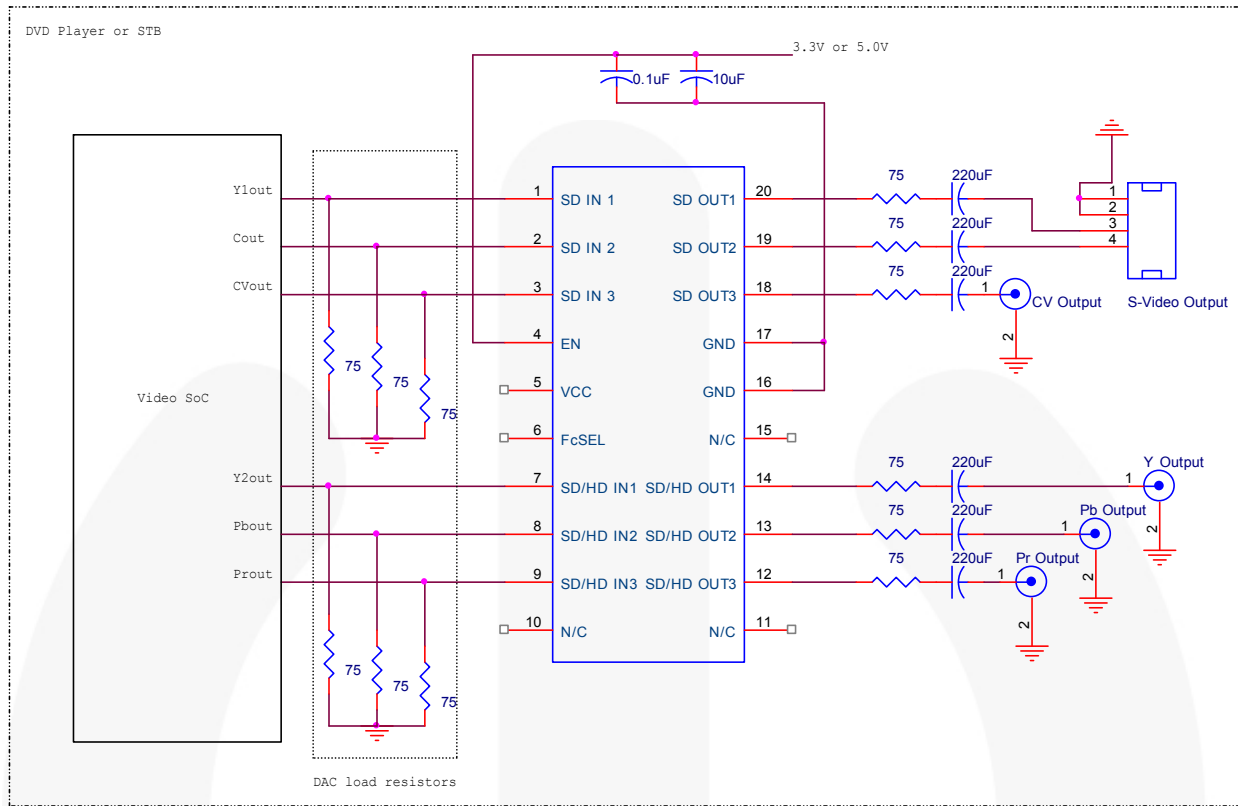
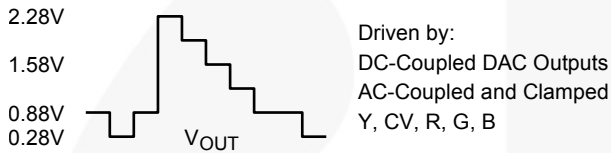
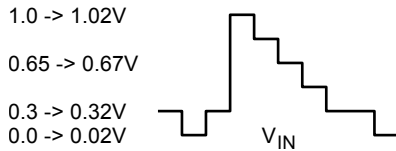


Figure 9. Typical Application

Applications Information

Functional Description

The FMS6346E VoltagePlus™ video filter provides 6dB gain from input to output. In addition, the input is slightly offset to optimize the output driver performance. The offset is held to the minimum required value to decrease the standing DC current into the load. Typical voltage levels are shown in Figure 10.



There is a 280mV offset from the DC input level to the DC output level. $V_{OUT} = 2 \cdot V_{IN} + 280mV$.

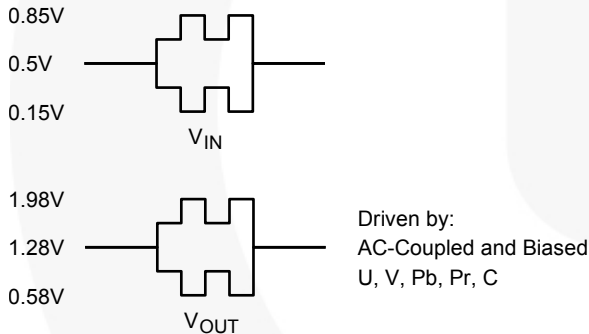


Figure 10. Typical Voltage Levels

The FMS6346E offers three channels with internal diode clamps and three channels with biasing to support AC-coupled input signals. If the input signal does not go below ground, the input clamp does not operate. This allows DAC outputs to directly drive the FMS6346E without an AC-coupling capacitor. The worst-case sync-tip compression due to the clamp does not exceed 7mV. The input level set by the clamp, combined with the internal DC offset, keeps the output within its acceptable range. When the input is AC coupled, the diode clamp sets the sync-tip (or lowest voltage) just below ground.

For symmetric signals like C, Pb, and Pr; the average DC bias is fairly constant and the inputs are biased to set the DC input voltage to approximately 600mV. DAC outputs can also drive these same signals without the AC coupling capacitor. A conceptual illustration of the input clamp circuit is shown in Figure 11.

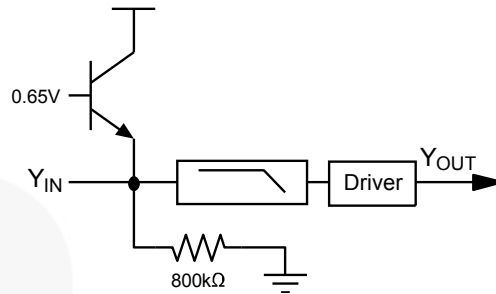


Figure 11. Input Clamp Circuit

I/O Configurations

For DC-coupled DAC drive with DC-coupled outputs, use the configuration shown in Figure 12.

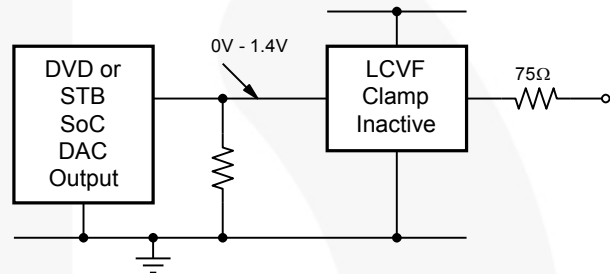


Figure 12. DC-Coupled Inputs and Outputs

If the DAC's average DC output level causes the signal to exceed the range of 0V to 1.4V, it can be AC coupled as shown in Figure 13.

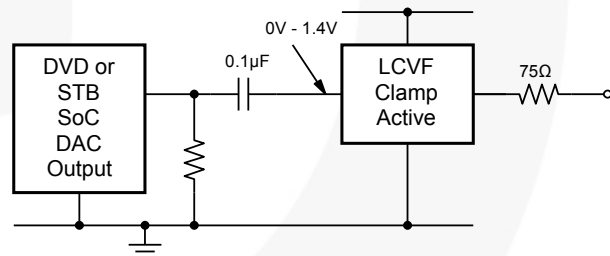


Figure 13. AC-Coupled Inputs, DC-Coupled Outputs

When driven by an unknown external source or a SCART switch with its own clamping circuitry, the inputs should be AC coupled as shown in Figure 14.

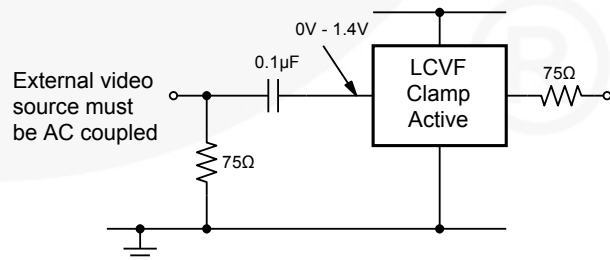


Figure 14. SCART Configuration with DC-Coupled Outputs

The same method can be used to bias the clamp signals.

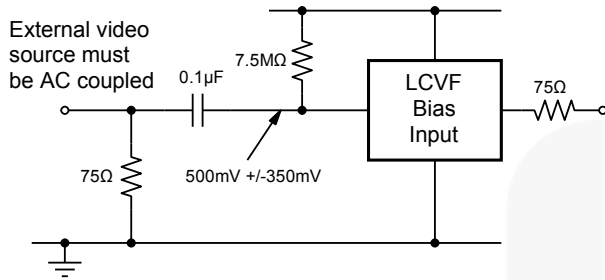


Figure 15. Biased SCART with DC-Coupled Outputs

The same circuits can be used with AC-coupled outputs if desired, as shown in Figure 16.

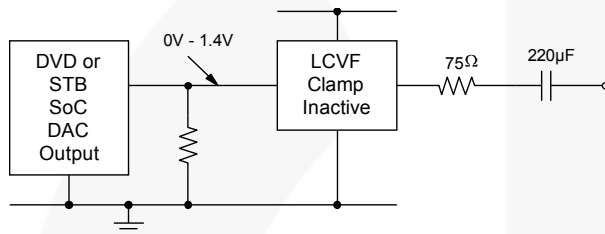


Figure 16. DC-Coupled Inputs, AC-Coupled Outputs

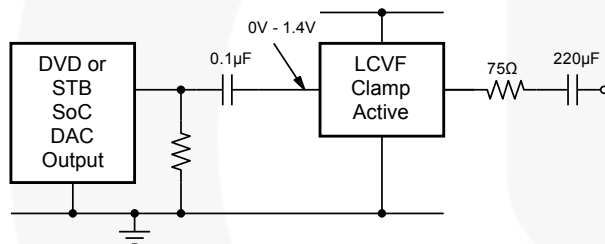


Figure 17. Coupled Inputs, AC-Coupled Outputs

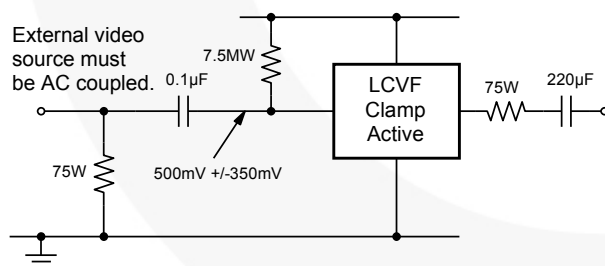


Figure 18. Biased SCART with AC-Coupled Outputs

Note:

- The video tilt or line time distortion is dominated by the AC-coupling capacitor. The value may need to be increased beyond 220µF to obtain satisfactory operation in some applications.

Power Dissipation

The FMS6346E output drive configuration must be considered when calculating overall power dissipation. Care must be taken not to exceed the maximum die junction temperature. The following example can be used to calculate the power dissipation and internal temperature rise:

$$T_J = T_A + P_d \cdot \theta_{JA} \quad (1)$$

where $P_d = P_{CH1} + P_{CH2} + P_{CHx}$ and

$$P_{CHx} = V_S \cdot I_{CH} - (V_O^2/R_L)$$

where $V_O = 2V_{IN} + 0.280V$

$$I_{CH} = (I_{CC} / 6) + (V_O/R_L)$$

V_{IN} = RMS value of input signal

$$I_{CC} = 50mA, V_S = 3.3V$$

R_L = channel load resistance

Board layout affects thermal characteristics. Refer to the *Layout Considerations* section for more information.

Output Considerations

The FMS6346E outputs are DC offset from the input by 150mV; therefore $V_{OUT} = 2 \cdot V_{IN} DC + 150mV$. This offset is required to obtain optimal performance from the output driver and is held at the minimum value to decrease the standing DC current into the load. Since the FMS6346E has a 2 x (6dB) gain, the output is typically connected via a 75Ω series back-matching resistor followed by the 75Ω video cable. Due to the inherent divide by two of this configuration, the blanking level at the load of the video signal is always less than 1V. When AC-coupling the output, ensure that the coupling capacitor passes the lowest frequency content in the video signal and that line time distortion (video tilt) is kept as low as possible.

The selection of the coupling capacitor is a function of the subsequent circuit input impedance and the leakage current of the input driver. To obtain the highest quality output video signal, the series termination resistor must be placed as close to the device output pin as possible. This greatly reduces the parasitic capacitance and inductance effect on the output driver. The distance from the device pin to the series termination resistor should be no greater than 12.7mm (0.5in).

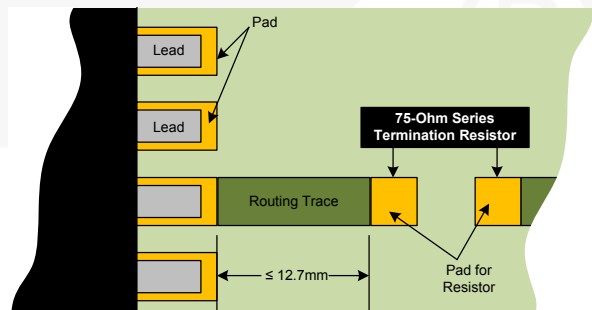


Figure 19. Termination Resistor Placement

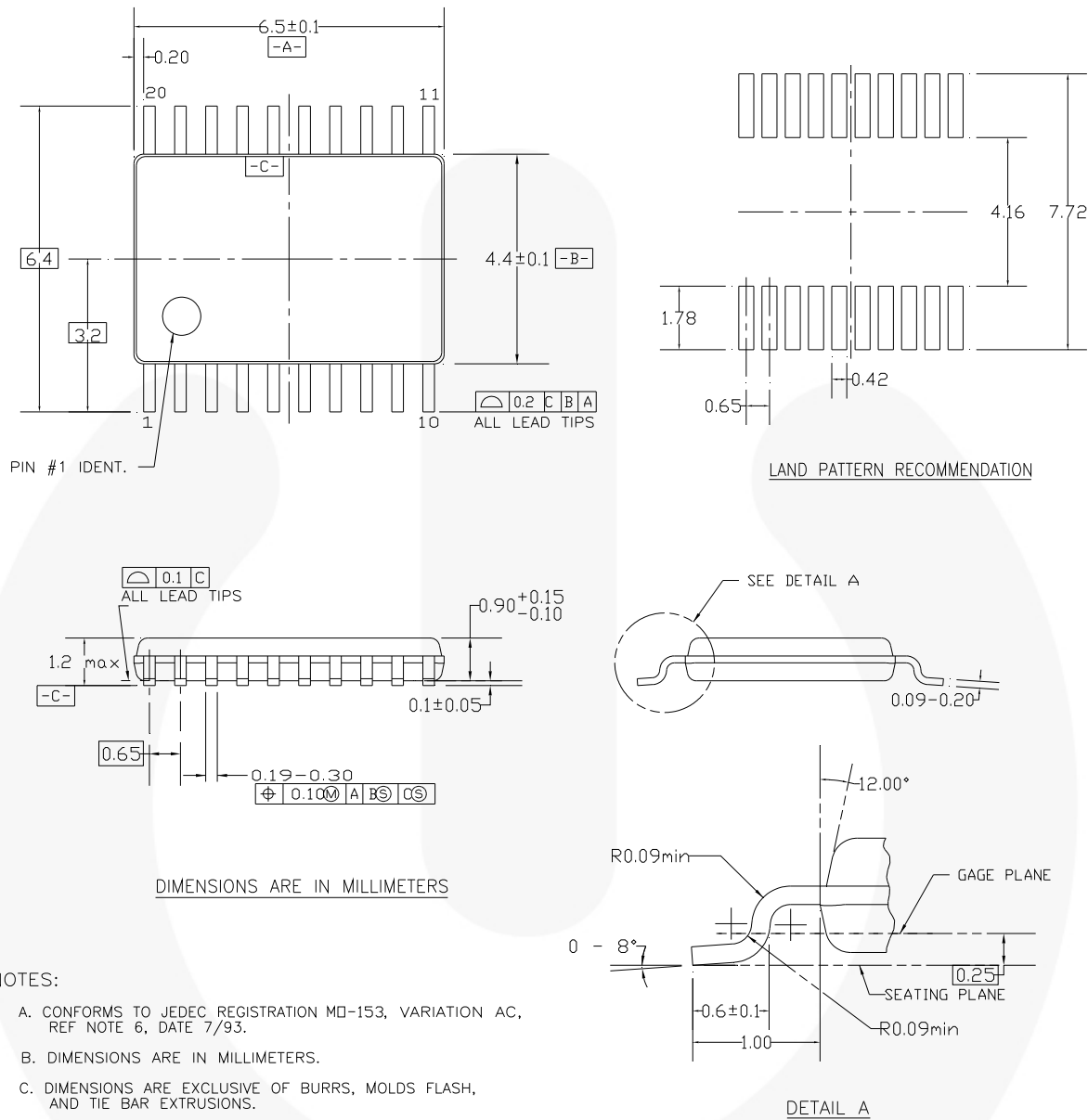
Layout Considerations

General layout and supply bypassing play major roles in high-frequency performance and thermal characteristics. Fairchild offers a demonstration board, FMS6346EDEMO, to guide layout and aid device testing and characterization.

The FMS6346EDEMO is a four-layer board with a full power and ground plane. Following this layout configuration provides the optimum performance and thermal characteristics. For best results, follow the steps below as a basis for high-frequency layout:

- Include 0.01 μ F and 0.1 μ F ceramic bypass capacitors.
- Place the 0.01 μ F capacitor within 0.75 inches of the power pin.
- Place the 0.1 μ F capacitor within 0.1 inches of the power pin.
- For multi-layer boards, use a large ground plane to help dissipate heat.
- For two-layer boards, use a ground plane that extends beyond the device by at least 0.5 inches.
- Minimize all trace lengths to reduce series inductances.

Physical Dimensions



MTC20REV D1

Figure 20. 20-Lead, Thin-Shrink Small-Outline Package (TSSOP)





Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
<http://www.fairchildsemi.com/packaging/>



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

- | | | | |
|--|--|--|---|
| 2Cool™ | FPS™ | PDP SPM™ | The Power Franchise® |
| AccuPower™ | F-PFS™ | Power-SPM™ | the power franchise |
| Auto-SPM™ | FRFET® | PowerTrench® | TinyBoost™ |
| AX-CAPT™* | Global Power Resource™ | PowerXST™ | TinyBuck™ |
| BitSic® | Green FPST™ | Programmable Active Droop™ | TinyCalc™ |
| Build it Now™ | Green FPST™ e-Series™ | QFET® | TinyLogic® |
| CorePLUS™ | Gmax™ | QST™ | TINYOPTO™ |
| CorePOWER™ | GTO™ | Quiet Series™ | TinyPower™ |
| CROSSVOL7™ | IntelliMAX™ | RapidConfigure™ | TinyPWM™ |
| CTL™ | ISOPLANAR™ |  ™ | TinyWire™ |
| Current Transfer Logic™ | Making Small Speakers Sound Louder and Better™ | Saving our world, 1mW/W/kW at a time™ | TranSiC® |
| DEUXPEED® | MegaBuck™ | SignalWise™ | TriFault Detect™ |
| Dual Cool™ | MI CROCOUPLER™ | SmartMax™ | TRUECURRENT®* |
| EcoSPARK® | MicroFET™ | SMART START™ | µSerDes™ |
| EfficientMax™ | MicroPak™ | SPM® |  ™ |
| ESBC™ | MicroPak2™ | STEALTH™ | UHC® |
|  Fairchild® | MillerDrive™ | SuperFET® | Ultra FRFET™ |
| Fairchild Semiconductor® | MotionMax™ | SuperSOT™-3 | UniFET™ |
| FACT Quiet Series™ | Motion-SPM™ | SuperSOT™L6 | VCX™ |
| FACT® | mWSaver™ | SuperSOT™L8 | VisualMax™ |
| FAST® | OptoHiT™ | SupreMOS® | VoltagePlus™ |
| FastvCore™ | OPTOLOGIC® | SyncFET™ | XST™ |
| FETBench™ | OPTOPLANAR® | Sync-Lock™ | |
| FlashWriter®* | |  SYSTEM GENERAL®* | |

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I57

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local
Sales Representative